VUTL006R950NA

Datasheet

General Description

$V_{(BR)DSS}$	$R_{DS(ON)\_max}$	I_D
60V	95mΩ@10V	10A
	110mΩ@4.5V	

Symbol

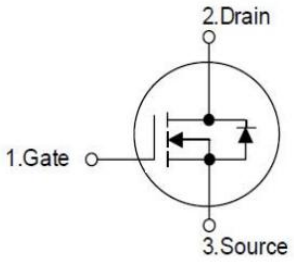


Figure 1 Symbol of VUTL006R950NA

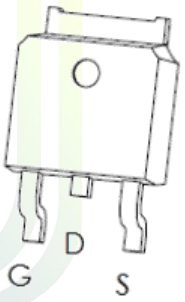
Features

- Trench Technology Power MOSFET
- Low $R_{DS(ON)}$
- Low Gate Charge
- Low Gate Resistance
- 100% UIS Tested

Application

- Power Switch Application

Package Type



TO-252-2L

Figure 2 Package Type of VUTL006R950NA

Ordering Information

Product Name	Package
VUTL006R950NA	TO-252-2L

Absolute Maximum Ratings (T_A= 25 ºC, unless otherwise specified)

Parameter		Symbol	Rating	Unit
Drain-Source Voltage		V_{DSS}	60	V
Gate-Source Voltage		V_{GSS}	±20	V
Continuous Drain Current[Note1]	T_C= 25 ºC	I_D	10	A
Continuous Drain Current[Note1]	T_C= 100 ºC		8	
Pulsed Drain Current [Note2]		I_{DM}	40	
Avalanche Current[Note3]		I_{AS}	11	
Single Pulsed Avalanche Energy[Note3]		E_{AS}	6	mJ
Total Power Dissipation[Note5]	T_C= 25 ºC	P_D	25	W
Junction Temperature		T_J	150	ºC
Storage Temperature		T_{STG}	-55 to 150	ºC

Thermal Resistance

Parameter	Symbol	Min	Typ	Max	Unit
Thermal Resistance, Junction-to-Ambient[Note6]	$R_{\theta JA}$		50		ºC/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$		5		ºC/W

Electrical Characteristics (T_J= 25 ºC, unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Statistic Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V, I_D= 250uA	60			V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}= 60V, V_{GS}=0V			1	uA
Gate-Body Leakage Current	I_{GSS}	V_{GS} = ±20V, V_{DS}= 0V			±100	nA
Gate Threshold Voltage[Note4]	$V_{GS(th)}$	V_{DS}=V_{GS}, I_D=250uA	0.5	1.3	2.0	V
Static Drain-Source On-Resistance[Note4]	$R_{DS(ON)}$	V_{GS}=10V, I_D= 10A		75	95	mΩ
		V_{GS}=4.5V, I_D= 7A		85	110	
Forward Transconductance[Note4]	g_{FS}	V_{DS}=5V, I_D= 5A		14		S
Dynamic Characteristics						
Input Capacitance	C_{ISS}	V_{DS}=30V		457		pF
Output Capacitance	C_{OSS}	V_{GS}=0V		27		pF
Reverse Transfer Capacitance	C_{RSS}	f=1MHz		23		pF
Total Gate Charge	Q_g	V_{DS}=30V		10.4		nC
Gate-Source Charge	Q_{gs}	V_{GS}=10V		1.8		
Gate-Drain Charge	Q_{gd}	I_D= 3A		2.1		
Gate Resistance	Rg	f = 1MHz, Open drain		2.7		Ω
Switching Parameters						
Turn-on Delay Time	$t_{d(on)}$	V_{DD}= 30V		7		ns
Turn-on Rise Time	t_r	V_{GS}= 10V		3		
Turn-off Delay Time	$t_{d(off)}$	R_L=0.75Ω		18		
Turn-off Fall Time	t_f	R_G=3Ω		3		
Diode Characteristics						
Diode Forward Voltage [Note4]	V_{SD}	V_{GS}=0V, I_S= 20A			1.2	V
Diode Reverse Recovery Time	t_{rr}	I_F = 5A, dI/dt = 500A/ms		15		ns
Diode Reverse Recovery Charge	Q_{rr}	I_F = 5A, dI/dt = 500A/ms		52		nC

Notes :

1.The maximum current rating is limited by package.And device mounted on a large heatsink.

2.Pulse Test : Pulse Width ≤ 10μs, duty cycle ≤ 1%.

3.E_{AS} condition: V_{DD} = 30V, V_{GS} = 10V, L = 0.1mH, R_G=25Ω Starting T_J = 25°C.

4.Pulse Test : Pulse Width ≤ 300μs, duty cycle ≤ 2%.

5.The power dissipation P_D is limited by $T_{J(MAX)}$ = 150°C.And device mounted on a large heatsink

6.Device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C.

Typical Performance Characteristics

Figure 3: Transfer Characteristics

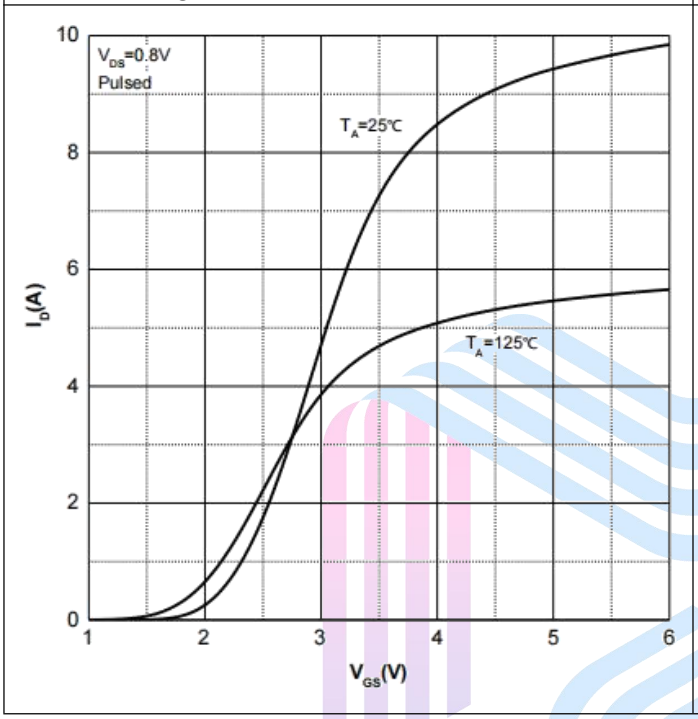


Figure 4: Output Characteristics

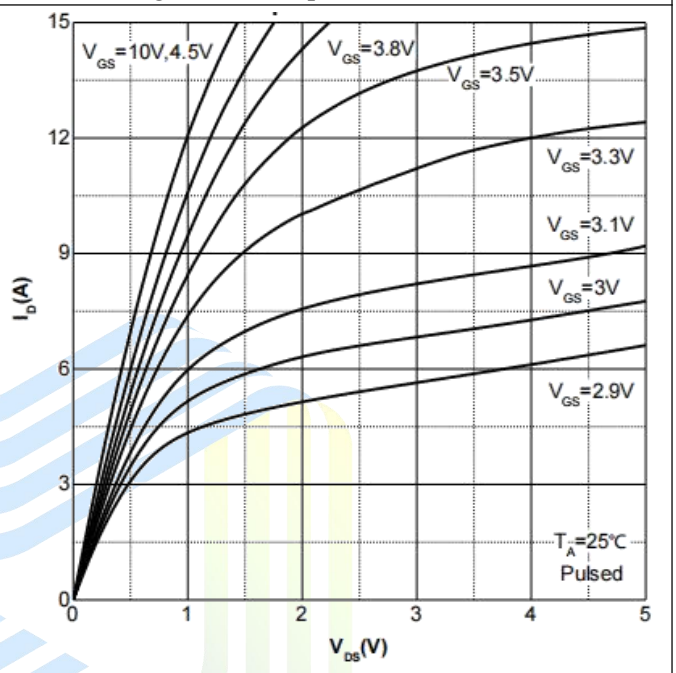


Figure 5: On-Resistance vs. Drain Current

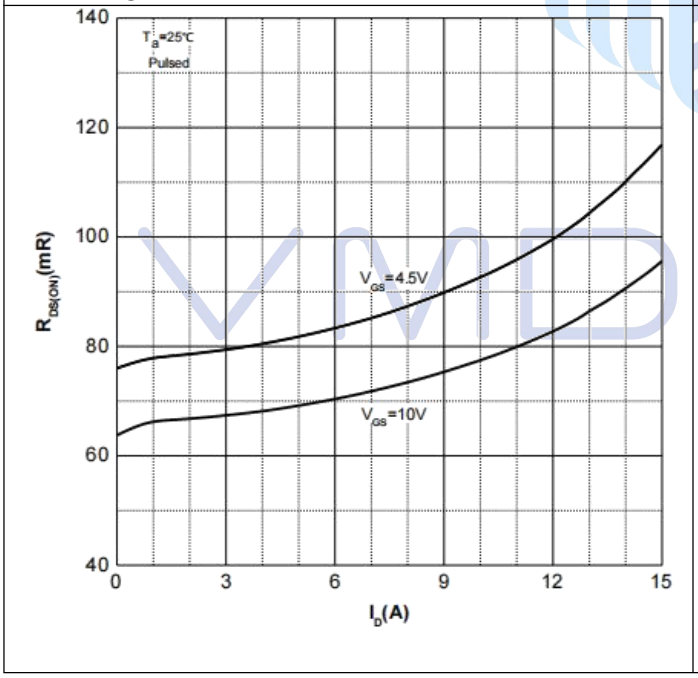


Figure 6: On-Resistance vs. Gate Voltage

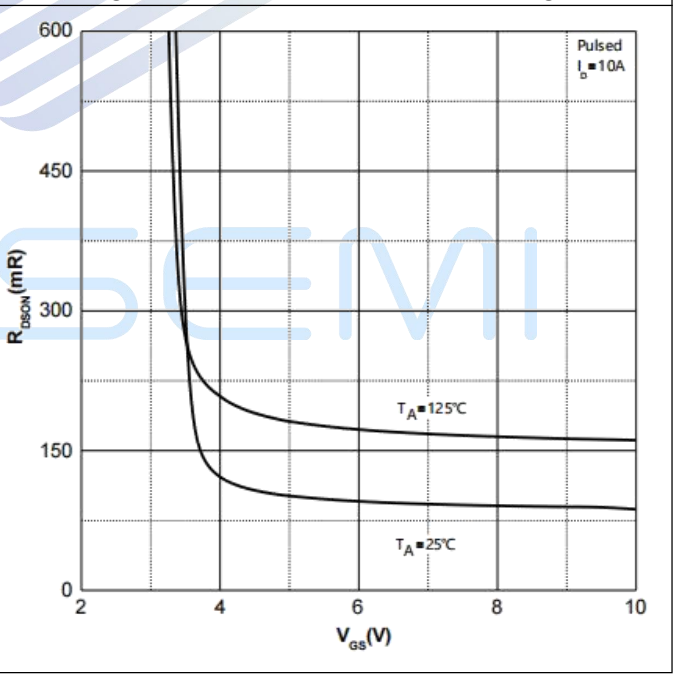


Figure 7: Body Diode Characteristics

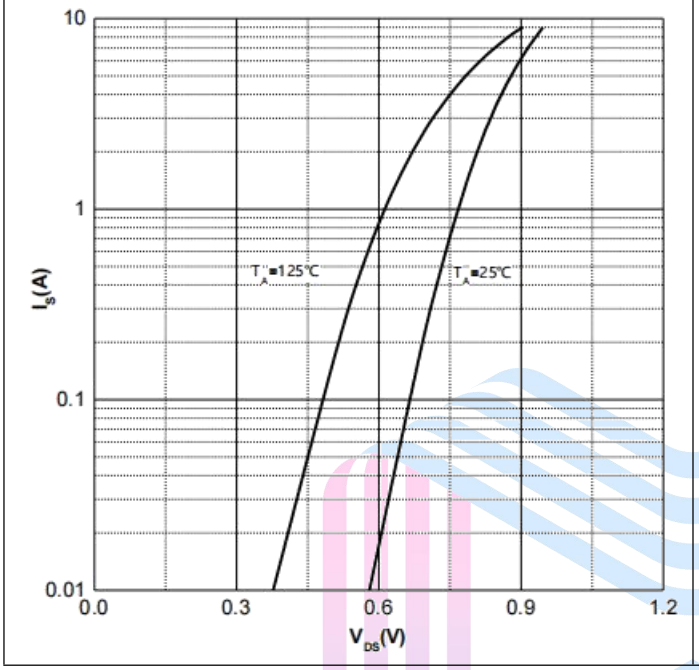


Figure 8: Threshold Voltage

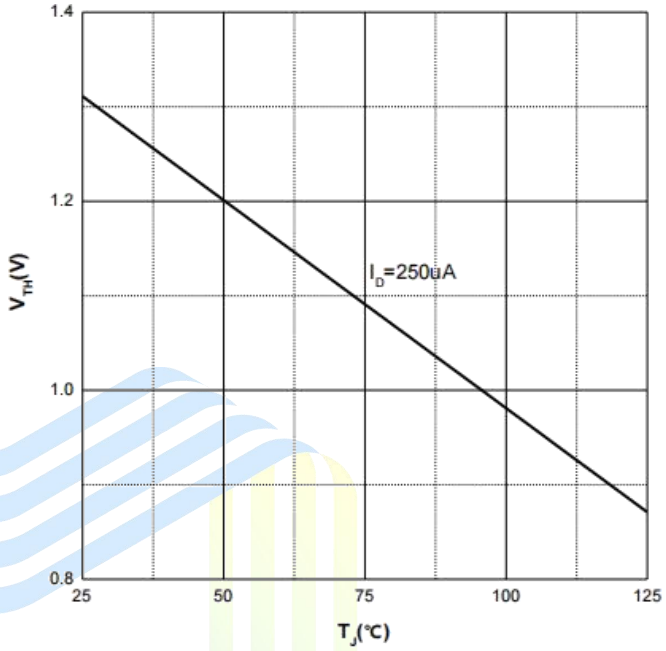


Figure 9: Typical Capacitance

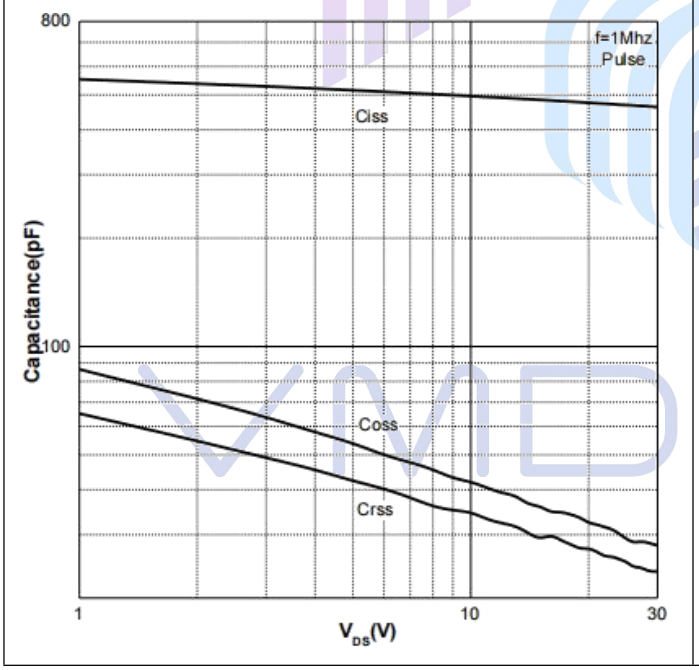


Figure 10: Safe Operation Area

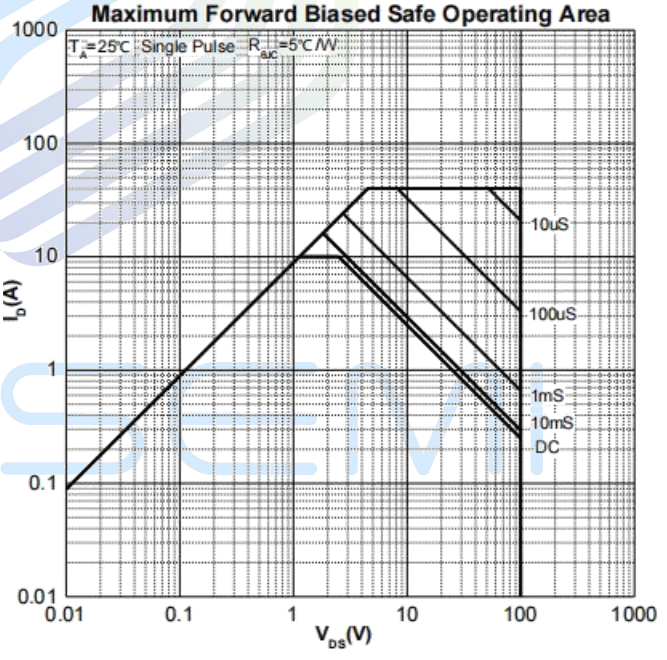
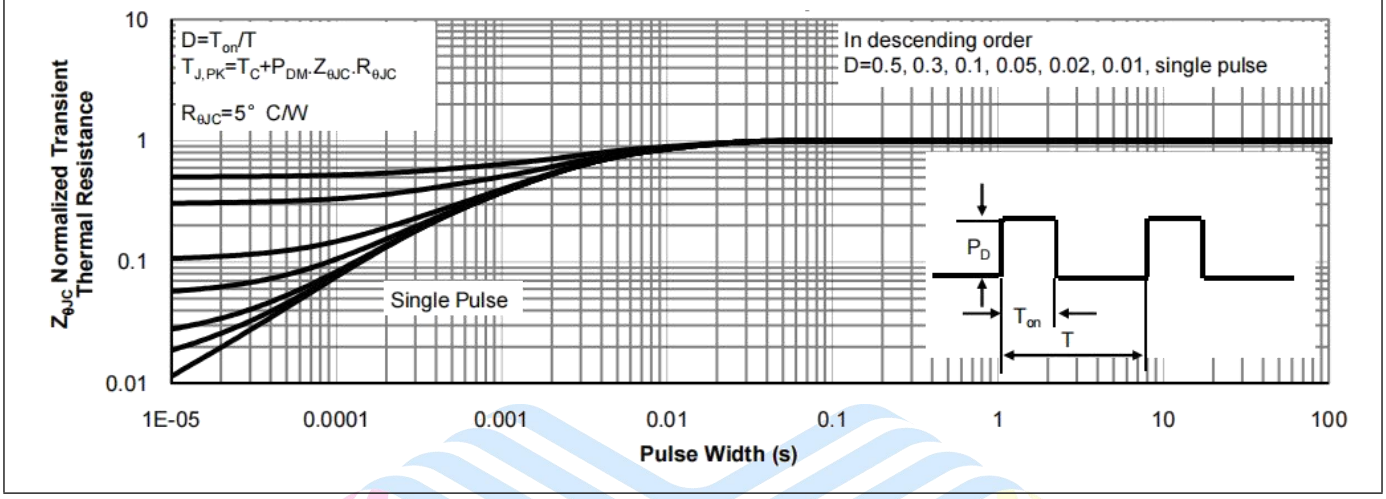
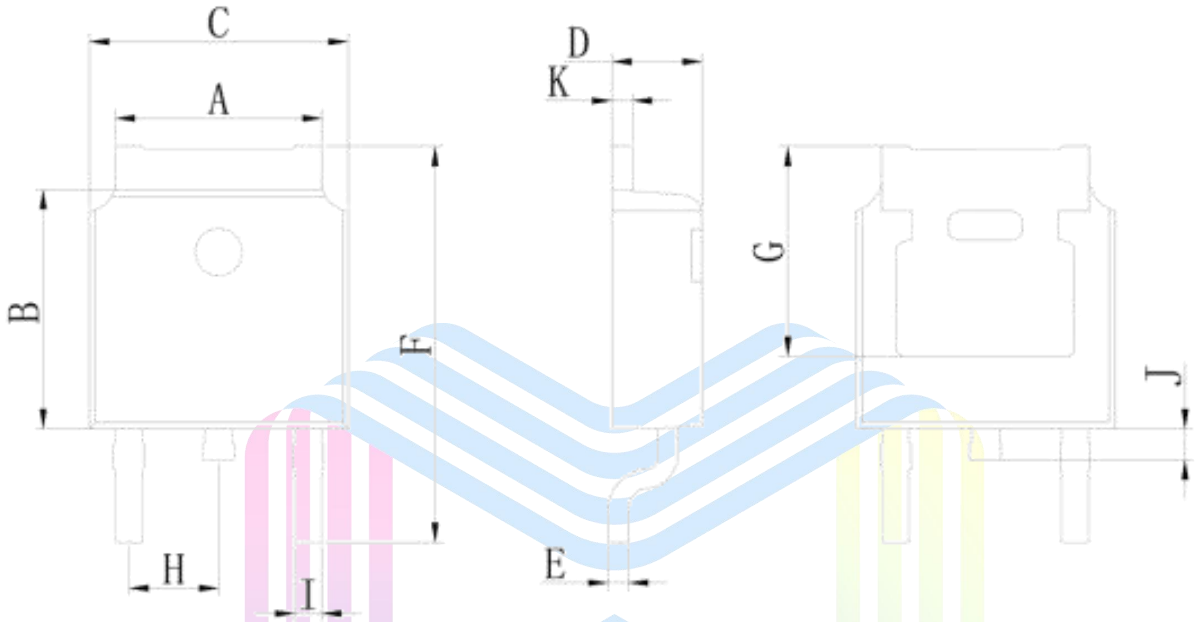


Figure 11: Normalized Maximum Transient Thermal Impedance



Mechanical Dimensions:

TO-252-2L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	5.050	5.650	0.199	0.222
B	5.800	6.400	0.228	0.252
C	6.250	6.850	0.246	0.270
D	2.200	2.400	0.087	0.094
E	0.400	0.600	0.016	0.024
F	9.710	10.310	0.382	0.406
G	5.050	5.650	0.199	0.222
H	2.100	2.500	0.083	0.098
I	0.700	0.900	0.028	0.035
J	0.500	0.900	0.020	0.035
K	0.400	0.600	0.016	0.024

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Via-Media Semiconductor Limited Company

http://www.vmdsemi.com

Main Sites:

- **Headquarters**

Hangzhou Via-Media Semiconductor Co., LTD.
1305-1306, Building 71, No. 90, Wensan Road, Xihu District, Hangzhou, Zhejiang Province, P.R. China
Tel: +86-0571-8515 0563

- **Chengdu Office**

Chengdu Winhi Semiconductor Co., LTD.
Floor 15, Building 5, No. 171, Hele 2nd Street, Chengdu, Sichuan Province, P.R. China
Tel: +86-028-8505 0771

- **Shanghai**

Shanghai R&D Center.
1506~1508, Xinyin Building, 888 Yishan Road, Shanghai, P.R of China
Tel: +86- 021-54201999

- **Shenzhen**

Shenzhen Sales office
Room 4A15, Block AB, Tianxiang Building, Chegongmiao , Futian District, Shenzhen, P.R of China
Tel: +86-0755- 82570682

- **Xi'an**

Xi'an R&D Center
1703B, Building A, Greenland Center, Jinye Road, High-Tech Zone, Xi'an, Shaanxi, P.R of China